1. General description

Standard recovery power diode in a TO252 (DPAK) surface-mountable plastic package.

2. Features and benefits

- · Low forward voltage drop
- · High inrush current capability
- · Surface-mountable package, ideally suited for automated assembly

3. Applications

- Input rectifier
- Bypass diode in PFC
- Snubber circuit

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V _R	reverse voltage	DC		-	-	800	٧	
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 132 °C; square-wave pulse; Fig. 1; Fig. 1; Fig. 3		-	-	8	Α	
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4		-	-	150	Α	
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	5 °C; sine-wave	-	-	165	A	
Static characte	Static characteristics							
V _F	forward voltage	I _F = 8 A; T _j = 25 °C; <u>Fig. 6</u>		_	0.97	1.1	V	
		I _F = 8 A; T _j = 150 °C; <u>Fig. 6</u>		-	0.84	1.1	V	

Standard power diode

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode		K — A
2	K	cathode[1]		001aaa020
3	Α	anode		
mb	К	mounting base; connected to cathode	DPAK (TO252N)	

^[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
SK8D	DPAK	plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	TO252N				

Standard power diode

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage		-	800	V
V_{RWM}	crest working reverse voltage		-	800	V
V_R	reverse voltage	DC	-	800	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 132 °C; square-wave pulse; Fig. 1; Fig. 1; Fig. 3	-	8	А
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	-	150	А
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	-	165	А
T _{stg}	storage temperature		-55	150	°C
Tj	junction temperature		-	150	°C

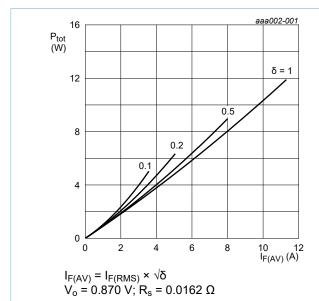


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

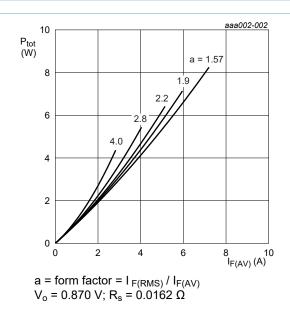


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

Standard power diode

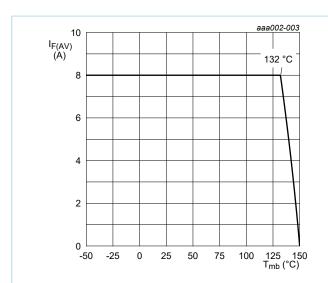


Fig. 3. Average current as a function of mounting base temperature; maximum values

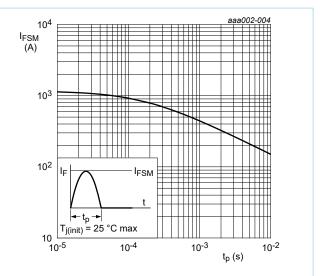


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

Standard power diode

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 5	-	-	2	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

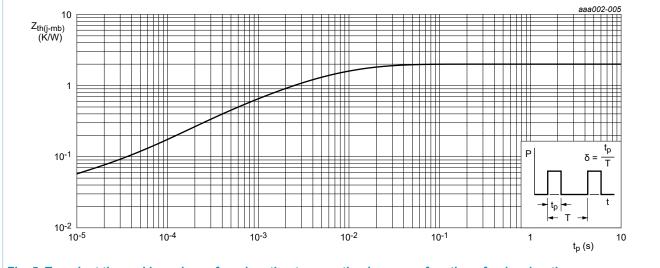


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

Standard power diode

9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static charac	Static characteristics						
V _F forward voltage	I _F = 8 A; T _j = 25 °C; <u>Fig. 6</u>		-	0.97	1.1	V	
		I _F = 8 A; T _j = 150 °C; <u>Fig. 6</u>		-	0.84	1.1	V
I _R reverse current	$V_R = 800 \text{ V}; T_j = 25 ^{\circ}\text{C}$		-	-	0.05	mA	
	V _R = 800 V; T _j = 150 °C		-	-	0.5	mA	

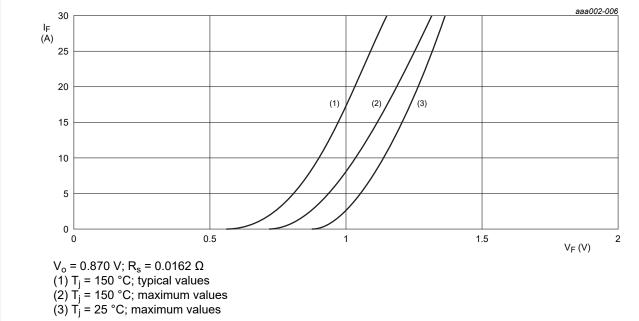
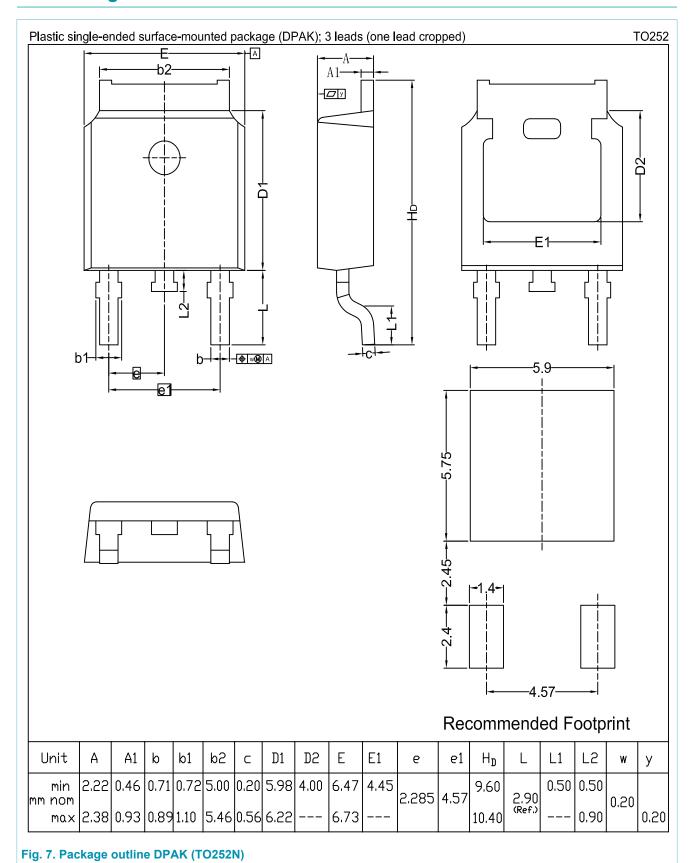


Fig. 6. Forward current as a function of forward voltage

10. Package outline



Standard power diode

11. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Standard power diode

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